Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS III)

TPCF8102

Notebook PC Applications Portable Equipment Applications

• Low drain-source ON resistance: RDS (ON) = 24 m Ω (typ.)

• High forward transfer admittance: $|Y_{fs}| = 14 \text{ S (typ.)}$

• Low leakage current: $IDSS = -10 \mu A (max) (VDS = -20 V)$

• Enhancement mode: $V_{th} = -0.5 \text{ to } -1.2 \text{ V}$

 $(V_{DS} = -10 \text{ V}, I_{D} = -200 \text{ } \mu\text{A})$

Absolute Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-20	V	
Drain-gate voltage (R	GS = 20 kΩ)	V_{DGR}	-20	V	
Gate-source voltage		V_{GSS}	±8	V	
Drain current	DC (Note 1)	I _D	-6	А	
	Pulsed (Note 1)	I _{DP}	-24		
Drain power dissipation	on (t = 5 s) (Note 2a)	P _D	2.5	W	
Drain power dissipation	on (t = 5 s) (Note 2b)	P _D	0.7	W	
Single pulse avalanch	ne energy (Note 3)	E _{AS}	5.9	mJ	
Avalanche current		I _{AR}	-3	Α	
Repetitive avalanche	energy (Note 4)	E _{AR}	0.25	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	-55~150	°C	

2-3U1A

Weight: 0.011 g (typ.)

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Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

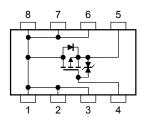
Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R _{th (ch-a)}	50.0	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.6	°C/W

Note: (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5): See the next page.

This transistor is an electrostatic-sensitive device. Please handle with caution.

Circuit Configuration



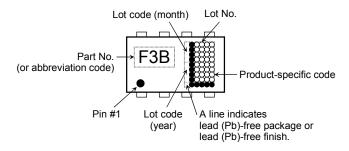
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I _{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	_		±10	μА	
Drain cut-off curr	rain cut-off current		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-10	μА	
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-20	_	_	V	
		V (BR) DSX	$I_D = -10 \text{ mA}, V_{GS} = 8 \text{ V}$	-12	_		, v	
Gate threshold v	oltage	V _{th}	$V_{DS} = -10 \text{ V}, I_D = -200 \mu\text{A}$	-0.5	_	-1.2	V	
		R _{DS (ON)}	$V_{GS} = -1.8 \text{ V}, I_D = -1.5 \text{ A}$	_	67	90		
Drain-source ON resistance		R _{DS (ON)}	$V_{GS} = -2.5 \text{ V}, I_D = -3.0 \text{ A}$	_	36	41	mΩ	
		R _{DS (ON)}	$V_{GS} = -4.5 \text{ V}, I_D = -3.0 \text{ A}$	_	24	30		
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -3.0 \text{ A}$	7	14	_	S	
Input capacitance		C _{iss}		_	1550	_	pF	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	215	_		
Output capacitance		Coss		_	265	_		
Switching time	Rise time	t _r	VGS -5 V ID = -3.0 A GE EEEE = 18	_	7			
	Turn-on time	t _{on}		_	13		- ns	
	Fall time	t _f	4.7Ω 3	_	21			
	Turn-off time	t _{off}	$V_{DD} \simeq -10 \text{ V}$ Duty \leq 1%, $t_W =$ 10 μs	_	68			
Total gate charge (gate-source plus gate-drain)		Qg	V _{DD} ≃ −16 V, V _{GS} = −5 V,		19			
Gate-source charge		Q _{gs}	$I_D = -6.0 \text{ A}$	_	14	_	nC	
Gate-drain ("miller") charge		Q _{gd}]	_	5	_		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics Symbol		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	_	_	_	-24	Α
Forward voltage (diode) V _{DSF}		V _{DSF}	$I_{DR} = -6.0 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

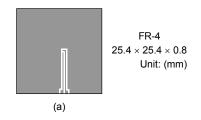
Marking (Note 5)

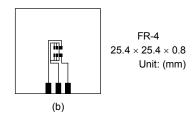


Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)



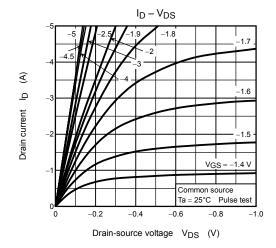


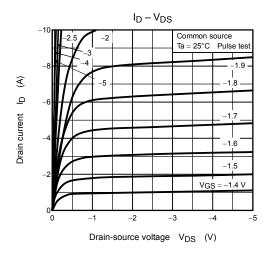
Note 3: $V_{DD} = -16~V$, $T_{ch} = 25^{\circ}C$ (initial), L = 0.5~mH, $R_G = 25~\Omega$, $I_{AR} = -3.0~A$

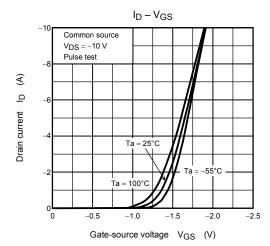
Note 4: Repetitive rating: pulse width limited by maximum channel temperature

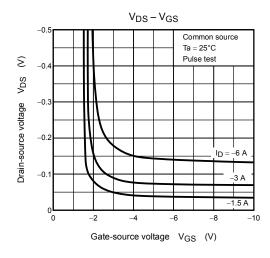
Note 5: A dot on the lower left of the marking indicates Pin 1.

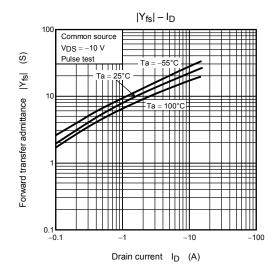
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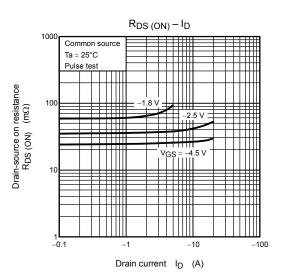




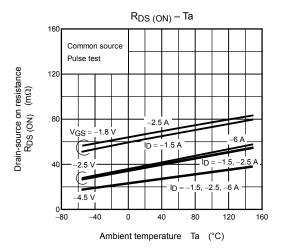


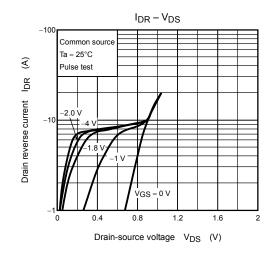


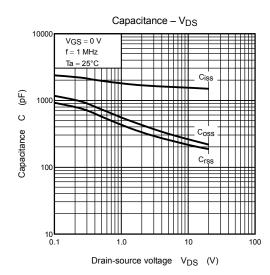


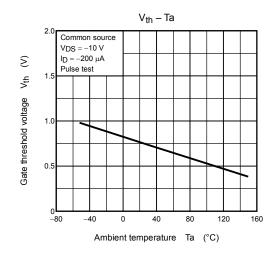


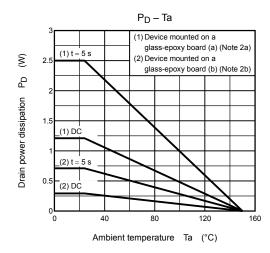
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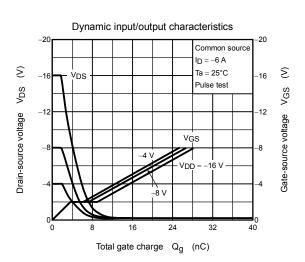


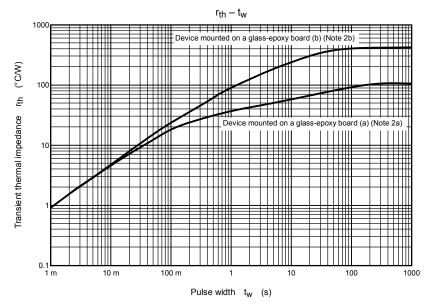


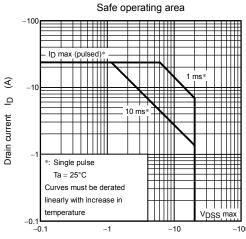












Drain-source voltage V_{DS} (V)

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